	Application No.	Applicant(s)
Notice of Allowability	09/516,080	BOLKEN, TODD O.
	Examin r	Art Unit
	Wai-Sing Louie	2814
The MAILING DATE of this communication appears on the cover sheet with the correspondence address All claims being allowable, PROSECUTION ON THE MERITS IS (OR REMAINS) CLOSED in this application. If not included herewith (or previously mailed), a Notice of Allowance (PTOL-85) or other appropriate communication will be mailed in due course. THIS NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RIGHTS. This application is subject to withdrawal from issue at the initiative of the Office or upon petition by the applicant. See 37 CFR 1.313 and MPEP 1308.		
1. This communication is responsive to 7/28.		
2. The allowed claim(s) is/are 1-14 and 16-20.		
3. The drawings filed on <u>01 March 2000</u> are accepted by the Examiner.		
 4. ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) ☐ All b) ☐ Some* c) ☐ None of the: 		
1. Certified copies of the priority documents have been received.		
2. Certified copies of the priority documents have been received in Application No		
3. Copies of the certified copies of the priority documents have been received in this national stage application from the		
International Bureau (PCT Rule 17.2(a)).		
* Certified copies not received: 5. Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application) since a specific reference was included in the first sentence of the specification or in an Application Data Sheet. 37 CFR 1.78.		
(a) The translation of the foreign language provisional application has been received.		
6. Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121 since a specific reference was included in the first sentence of the specification or in an Application Data Sheet. 37 CFR 1.78.		
Applicant has THREE MONTHS FROM THE "MAILING DATE" of this communication to file a reply complying with the requirements noted below. Failure to timely comply will result in ABANDONMENT of this application. THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.		
7. A SUBSTITUTE OATH OR DECLARATION must be submitted. Note the attached EXAMINER'S AMENDMENT or NOTICE OF INFORMAL PATENT APPLICATION (PTO-152) which gives reason(s) why the oath or declaration is deficient.		
8. CORRECTED DRAWINGS (as "replacement sheets") must be submitted. (a) including changes required by the Notice of Draftsperson's Patent Drawing Review (PTO-948) attached 1) hereto or 2) to Paper No		
(b) including changes required by the proposed drawing correction filed, which has been approved by the Examiner.		
(c) 🔲 including changes required by the attached Examiner's Amendment / Comment or in the Office action of Paper No		
Identifying indicia such as the application number (see 37 CFR 1.84(c)) should be written on the drawings in the front (not the back) of each sheet. Replacement sheet(s) should be labeled as such in the margin according to 37 CFR 1.121(d).		
9. DEPOSIT OF and/or INFORMATION about the deposit of BIOLOGICAL MATERIAL must be submitted. Note the attached Examiner's comment regarding REQUIREMENT FOR THE DEPOSIT OF BIOLOGICAL MATERIAL.		
Attachm nt(s)		
1☐ Notice of References Cited (PTO-892)	5⊡ Notice of Informal Pa	atent Application (PTO-152)
2 Notice of Draftperson's Patent Drawing Review (PTO-948)		(PTO-413), Paper No
3 Information Disclosure Statements (PTO-1449 or PTO/SB/08 Paper No	3), 7☐ Examiner's Amendm	ient/Comment
4 Examiner's Comment Regarding Requirement for Deposit of Biological Material	8☐ Examiner's Statemer	nt of Reasons for Allowance
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Application/Control Number: 09/516,080

Art Unit: 2814

DETAILED ACTION

Allowable Subject Matter

Claims 1-14 and 16-20 are allowed. The following is an examiner's statement of reasons for allowance:

The claimed invention is a system for molding a circuit package comprising:

- A first support plate;
- A second support plate proximately positioned with respect to first support plate; and
- A cavity plate positioned between the first support plate and the second support plate, the cavity plate having an aperture configured to accept only a protruding portion of the circuit package such that the protruding portion of the circuit package contacts the first support plate, and where the aperture is sized to create a peripheral void about only the protruding portion of the circuit package to permit a molding compound to be disposed thereabout.

Reference Neu (US 5,405,255) discloses an encapsulation molding apparatus for encapsulating the entire IC chip; therefore, the circuit package does not contact the first support plate.

Reference Chia et al. (US 6,081,997) disclose a packaging system for encapsulating the IC chip. However, Chia et al. do not disclose a cavity plate.

Therefore, the above references do not disclose the claimed invention of the present application and claims 1-14 and 16-20 are allowed.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Wai-Sing Louie whose telephone number is (571) 272-1709. The examiner can normally be reached on 7:30 AM to 4:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (571) 272-1562.

LONG PHAM PRIMARY EXAMINER

December 3, 2003.